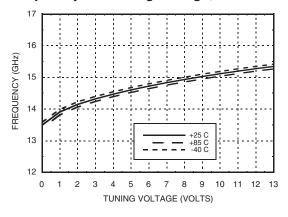


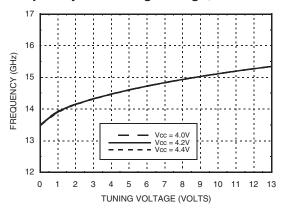


# MMIC VCO w/ HALF FREQUENCY OUTPUT 14.5 - 15.0 GHz

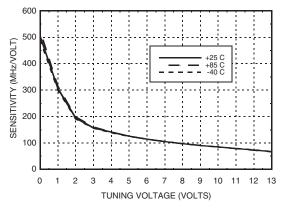
### Frequency vs. Tuning Voltage, Vcc = +4.2V



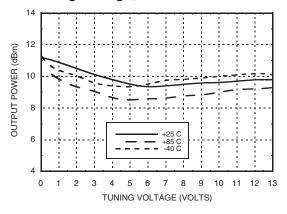
### Frequency vs. Tuning Voltage, T= 25°C



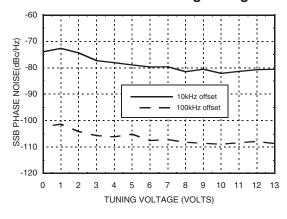
## Sensitivity vs. Tuning Voltage, Vcc = +4.2V



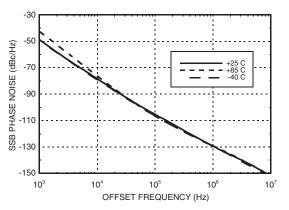
# Output Power vs. Tuning Voltage, Vcc = +4.2V



### SSB Phase Noise vs. Tuning Voltage



#### SSB Phase Noise @ Vtune = +5V



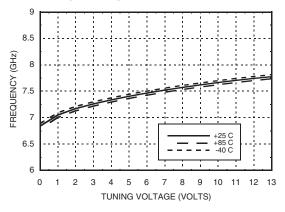
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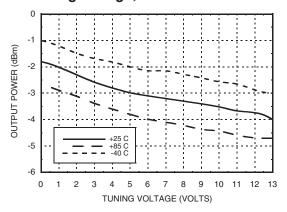


## MMIC VCO w/ HALF FREQUENCY OUTPUT 14.5 - 15.0 GHz

# RFOUT/2 Frequency vs. Tuning Voltage, Vcc = +4.2V



# RFOUT/2 Output Power vs. Tuning Voltage, Vcc = +4.2V



## **Absolute Maximum Ratings**

Vcc	+5.5V
Vtune	0 to 15V
Junction Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 19.6 mW/C above 85 °C	1 W
Thermal Resistance (junction to ground paddle)	51 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

## Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
4.0	140
4.2	150
4.4	160

Note: VCO will operate over full voltage range shown above.



## Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking [3]
HMC736LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H736 XXXX
HMC736LP4E RoHS-compliant Low Stress Injection Molded Plastic		100% matte Sn	MSL1 [2]	<u>H736</u> XXXX

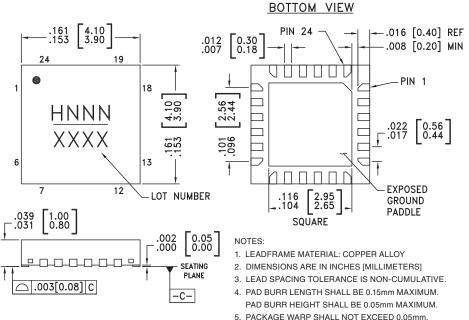
- [1] Max peak reflow temperature of 235  $^{\circ}\text{C}$
- [2] Max peak reflow temperature of 260  $^{\circ}\text{C}$
- [3] 4-Digit lot number XXXX





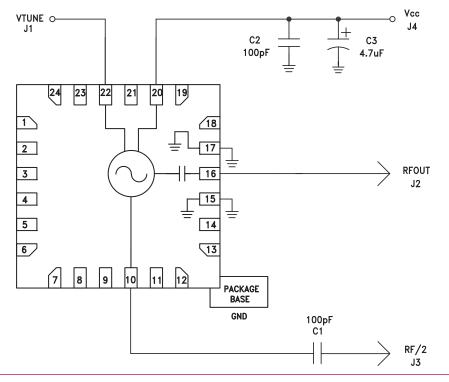
## MMIC VCO w/ HALF FREQUENCY OUTPUT 14.5 - 15.0 GHz

### **Outline Drawing**



- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

## **Application Circuit**



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# MMIC VCO w/ HALF FREQUENCY OUTPUT 14.5 - 15.0 GHz

## Pin Descriptions

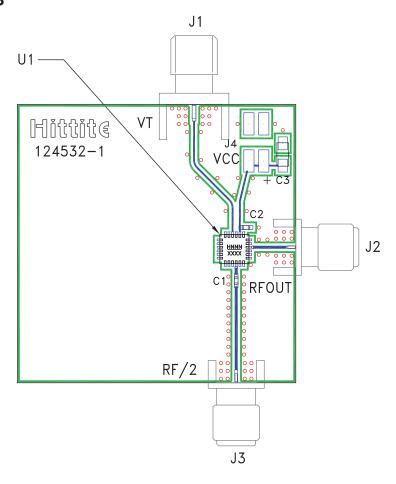
Pin Number	Function	Description	Interface Schematic
1 - 9, 11 - 14, 18, 19, 21, 23, 24	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
10	RFOUT/2	Half frequency output (AC coupled). Requires external AC coupling capacitor.	RFOUT/2
16	RFOUT	RF output (AC coupled).	RFOUT
20	Vcc	Supply Voltage, +4.2V	Vcc O48pF
22	VTUNE	Control voltage and modulation input. Modulation bandwidth dependent on drive source impedance. See "Determining the FM Bandwidth of a Wideband Varactor Tuned VCO" application note.	VTUNEO
15, 17, Paddle	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	GND =





## MMIC VCO w/ HALF FREQUENCY OUTPUT 14.5 - 15.0 GHz

#### **Evaluation PCB**



## List of Materials for Evaluation PCB 123987 [1]

Item	Description
J1 - J3	PCB Mount SMA RF Connector
J4	2 mm DC Header
C1, C2	100 pF Capacitor, 0402 Pkg.
C3	4.7 μF Tantalum Capacitor
U1	HMC736LP4(E) VCO
PCB [2]	124532 Eval Board

[1] Reference this number when ordering complete evaluation PCB  $\,$ 

[2] Circuit Board Material: Arlon 25FR or Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.